

Special Issue

Advanced Active and Passive Metasurfaces

Message from the Guest Editors

This Special Issue on “Advanced Active and Passive Metasurfaces” in the journal *Applied Sciences* is aimed to summarize the recent advances in the development of active and passive metasurfaces and their related applications in the different fields of physics and engineering. The scope includes theoretical, computational and experimental contributions ranging from fundamental research to new designs and ideas for the development of advanced and functional applications of the metasurface concept. Topics of interest include but are not limited to:

- metasurface
- antennas
- lenses
- OAM
- surface
- plasmons
- non-reciprocity
- holography

Guest Editors

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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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